



42390.P7663

#17/Response
10/8/02
PATENT
Shmeltz

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Frutschy, et al.

Serial No.: 09/473,305

Filed: December 28, 1999

For: DIRECT BGA ATTACHMENT
WITHOUT SOLDER REFLOW

Examiner: N. Parekh

Group Art Unit: 2811

Attorney Docket No.: 42390.P7663

CERTIFICATE OF MAILING

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RESPONSE

Hon. Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

In response to the May 20, 2002 Office Action with the time for response having been extended by one month, please consider the following amendments and remarks.

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